



# SS12~SS1200

## Surface Mount Schottky Rectifiers

### Major Ratings and Characteristics

$I_{F(AV)}$	1.0 A
$V_{RRM}$	20 V to 200 V
$I_{FSM}$	30 A
$V_F$	0.55V, 0.7V, 0.85V, 0.95V
$T_j \text{ max.}$	150 °C

### SMA/DO-214AC

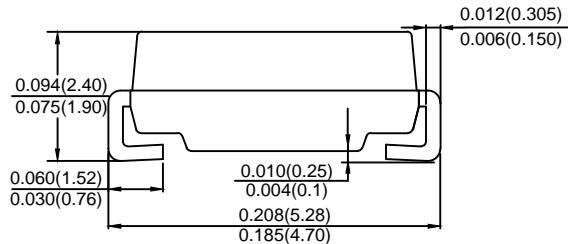
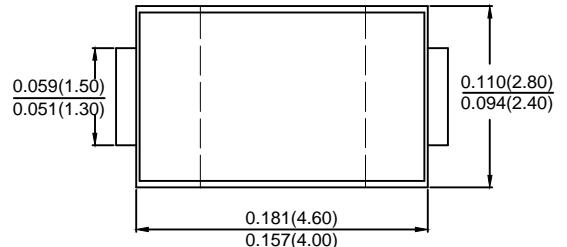


### Features

- Low profile package
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low power losses, high efficiency
- Low forward voltage drop
- High surge capability
- High temperature soldering:  
260°C/10 seconds at terminals
- Component in accordance to  
RoHS 2002/95/1 and WEEE 2002/96/EC

### Mechanical Data

- Case: JEDEC DO-214AC (SMA) molded plastic
- Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D
- Polarity: Laser band denotes cathode end



Dimensions in inches and (millimeters)

### Maximum Ratings & Thermal Characteristics & Electrical Characteristics

(TA = 25 °C unless otherwise noted)

	Symbol	SS12	SS14	SS16	SS18	SS110	SS1150	SS1200	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	20	40	60	80	100	150	200	V
Maximum RMS voltage	$V_{RMS}$	14	28	46	56	70	105	140	V
Maximum DC blocking voltage	$V_{DC}$	20	40	60	80	100	150	200	V
Maximum average forward rectified current	$I_{F(AV)}$					1			A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$					30			A
Maximum instantaneous forward voltage at 1.0A	$V_F$	0.55	0.7	0.85	0.95				V
Maximum DC reverse current $T_A = 25^\circ\text{C}$ at Rated DC blocking voltage $T_A = 100^\circ\text{C}$	$I_R$			0.5					mA
				5					mA
Voltage rate of change (rated VR)	$dv/dt$			10000					$\text{V}/\mu\text{s}$
Thermal resistance from junction to ambient	$R_{\theta JA}$			88					$^\circ\text{C}/\text{W}$
Operating junction and storage temperature range	$T_J, T_{STG}$			– 65 to +150					°C



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Characteristic Curves ( $T_A=25^\circ\text{C}$  unless otherwise noted)

Fig.1 Forward Current Derating Curve

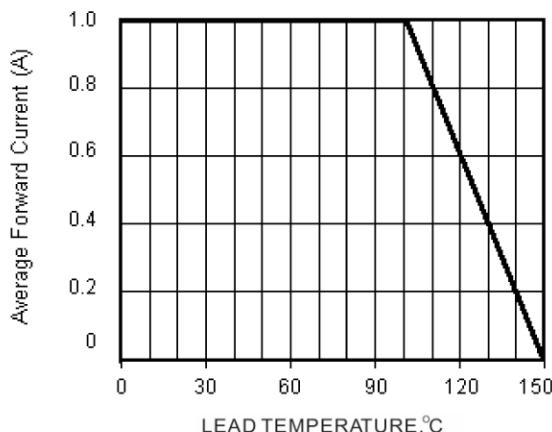


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

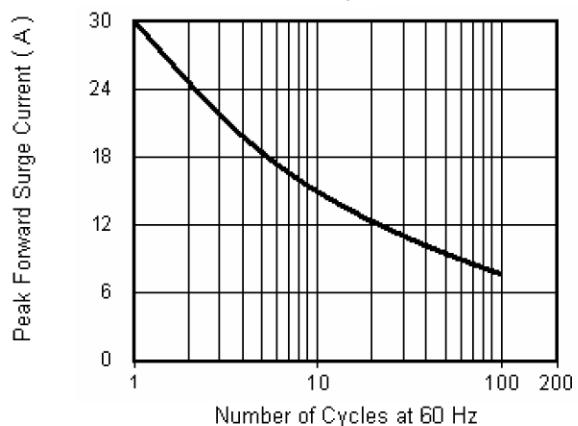


Fig.3 Typical Instantaneous Forward Characteristics

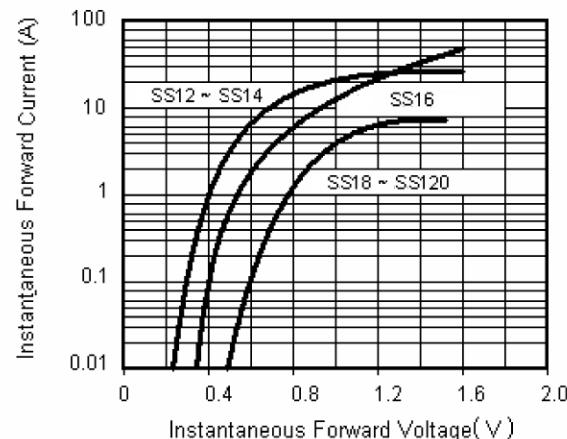


Fig.4 Typical Reverse Leakage Characteristics

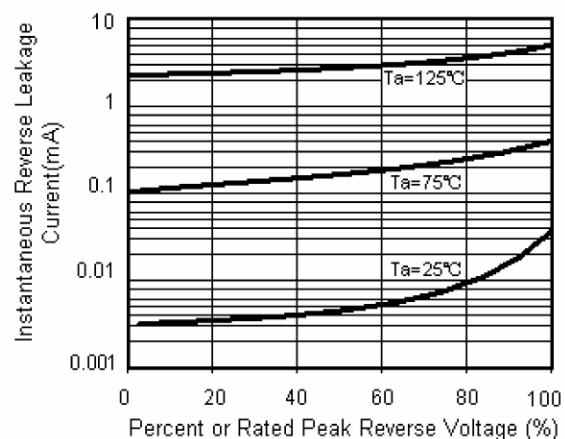


Fig.5 Typical Junction Capacitance

